

OLED PRODUCT SPECIFICATION

Manufactured by:



PART NUMBER:	USMP-P19301
DESCRIPTION:	2.7" OLED, 128x64, Yellow, Tab, SSD 1305

ISSUE DATE	APPROVED BY	CHECKED BY	PREPARED BY					
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REVISION RECORD

REV.	REVISION DESCRIPTION	REV. DATE	REMARK
X01	INITIAL RELEASE	2007. 12. 19	
X02	 ■ Modify typical luminance (80cd/m²→ 100cd/m²) ■ Add the operating conditions for different luminance ■ Add the panel electrical specifications ■ Modify power off sequence 	2008. 01. 03	Page 6, 7, 8 & 13

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1. SCOPE

The purpose of this specification is to define the general provisions and quality requirements that apply to the supply of display cells manufactured by RiTdisplay. This document, together with the Module Ass'y Drawing, is the highest-level specification for this product. It describes the product, identifies supporting documents and contains specifications.

2. WARRANTY

RiTdisplay warrants that the products delivered pursuant to this specification (or order) will conform to the agreed specifications for twelve (12) months from the shipping date ("Warranty Period"). RiTdisplay is obligated to repair or replace the products which are found to be defective or inconsistent with the specifications during the Warranty Period without charge, on condition that the products are stored or used as the conditions specified in the specifications. Nevertheless, RiTdisplay is not obligated to repair or replace the products without charge if the defects or inconsistency are caused by the force majeure or the reckless behaviors of the customer.

After the Warranty Period, all repairs or replacements of the products are subject to charge.

3. FEATURES

Small molecular organic light emitting diode.

Color : Yellow

Panel matrix : 128x64Driver IC : SSD1305

Excellent Quick response time: 10µs

- Extremely thin thickness for best mechanism design: 2.01mm High contrast: 2000:1

Wide viewing angle : 160°

- 8-bit 6800-series parallel interface, 8-bit 8080-series parallel interface, serial peripheral interface, I²C interface.
- Wide range of operating temperature : -40 to 70 °C
- Anti-glare polarizer.

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4. MECHANICAL DATA

NO	ITEM	SPECIFICATION	UNIT
1	Dot Matrix	128 (W) x 64 (H)	dot
2	Dot Size	0.45 (W) x 0.45 (H)	mm ²
3	Dot Pitch	0.48 (W) x 0.48 (H)	mm ²
4	Aperture Rate	88	%
5	Active Area	61.41 (W) x 30.69 (H)	mm ²
6	Panel Size	70.9 (W) x 41.86 (H)	mm ²
7	Panel Thickness	2.01	mm
8	Module Size	70.9 (W) x 111.61 (H) x 2.01 (T)	mm ³
9	Diagonal A/A size	2.7	inch
10	Module Weight	TBD	gram





5. MAXIMUM RATINGS

ITEM	MIN	MAX	UNIT	Condition	Remark
Supply Voltage (V _{DD})	-0.3	3.5	V	Ta = 25°C	IC maximum rating
Supply Voltage (Vcc)	8	16	>	Ta = 25°C	IC maximum rating
Operating Temp.	-40	70	°C		
Storage Temp	-40	85	°C		
Humidity		85	%		
Life Time	20,000	-	Hrs	120 cd/m², 50% checkerboard	Note (1)
Life Time	24,000	-	Hrs	100 cd/m², 50% checkerboard	Note (2)
Life Time	30,000	-	Hrs	80 cd/m ² , 50% checkerboard	Note (3)

Note:

(A) Under Vcc = 15VDC, Ta = 25°C, 50% RH.

(B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

(1) Setting of 120 cd/m²:

Contrast setting : 0xD0H

- Frame rate : 105Hz

- Duty setting: 1/64

(2) Setting of 100 cd/m²:

Contrast setting: 0x90H

Frame rate : 105Hz

Duty setting: 1/64

(3) Setting of 80 cd/m²:

Contrast setting: 0x50H

Frame rate: 105Hz

Duty setting: 1/64

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6. ELECTRICAL CHARACTERISTICS

6.1 D.C ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETERS	TEST CONDITION	MIN	TYP	MAX	UNIT
Vcc	Analog power supply (for OLED panel)	-	14.5	15	15.5	V
V_{DD}	Digital power supply	-	2.4	2.7	3.5	V
V _{DDIO}	Logic Supply Voltage for MCU interface	-	1.6	-	V_{DD}	V
Ірр	Operating current for V_{DD} V_{DD} = 2.7V, V_{CC} = 12V, IREF = 10uA, No panel attached, All Display ON	Contrast=FFh	-	100	300	uA
Icc, SLEEP Idd, SLEEP Iddio, SLEEP	Sleep mode Current	V _{DD} = 2.4 V~3.5V, V _{CC} = 7V~15V Display OFF, No panel attached	ı	-	10	uA
lcc	Operating current for V_{CC} V_{DD} = 2.7V, V_{CC} = 12V, IREF = 10uA, No panel attached, All Display ON	Contrast=FFh	-	550	1000	uA
VIH	High logic input level	-	0.8* V _{DDIO}	-	-	V
V _{IL}	Low logic input level	-	0	-	0.2* V _{DDIO}	V
V _{OH}	High logic output level	I _{OUT} = 100uA, 3.3MHz	0.9* V _{DDIO}	-	-	V
V _{OL}	Low logic output level	I _{OUT} = 100uA, 3.3MHz	0	-	0.1* V _{DDIO}	V
		Contrast=FFh	294	320	346	uA
	Segment Output Current	Contrast=AFh	-	220	-	uA
I _{SEG}	$V_{DD}=2.7V, V_{CC}=12V,$	Contrast=7Fh	-	159	-	uA
	I _{REF} =10uA, Display on,	Contrast=3Fh	-	79	-	uA
		Contrast=0Fh	-	19	-	uA

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6.2 ELECTRO-OPTICAL CHARACTERISTICS

PANEL ELECTRICAL SPECIFICATIONS

PARAMETER	MIN	TYP.	MAX	UNITS	COMMENTS
Normal mode current		28	30	mA	All pixels on (1)
Standby mode current		3	5	mA	Standby mode 10% pixels on (2)
Normal mode power consumption		420	450	mW	All pixels on (1)
Standby mode power consumption		45	75	mW	Standby mode 10% pixels on (2)
Normal mode Luminance	80	100		cd/m ²	Display Average
Standby mode Luminance		60		cd/m ²	Display Average
CIEx (Yellow)	0.43	0.47	0.51		v v (CIE 1021)
CIEy (Yellow)	0.45	0.49	0.53		x, y (CIE 1931)
Dark Room Contrast	2000:1				
Viewing Angle	160			degree	
Response Time		10		μs	

(1) Normal mode condition:

Driving Voltage : 15VDCContrast setting : 0x90H

Frame rate : 105HzDuty setting : 1/64

(2) Standby mode condition:

Driving Voltage : 15VDCContrast setting : 0x10H

Frame rate: 105HzDuty setting: 1/64

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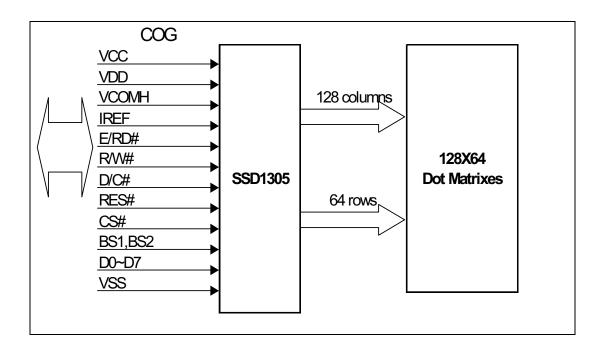
2008/01/03



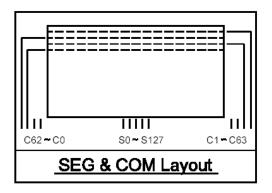


7. INTERFACE

7.1 FUNCTION BLOCK DIAGRAM



7.2 PANEL LAYOUT DIAGRAM



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7.3 PIN ASSIGNMENTS

PIN NAME	PIN NO	DESCRIPTION
VCC	1	Power supply for analog circuit.
VCOMH	2	Com Voltage Output. A capacitor should be connected between this pin and VSS.
IREF	3	Reference current input pin. A resistor should be connected between this pin and VSS.
D7	4	Data bus.
D6	5	Data bus.
D5	6	Data bus.
D4	7	Data bus.
D3	8	Data bus.
D2	9	Data bus.
D1	10	Data bus.
D0	11	Data bus.
E/RD#	12	Data read operation is initiated when it's pull low.
R/W#	13	Data write operation is initiated when it's pull low.
D/C#	14	Data/ Command control. Pull high for write/read display data. Pull low for write command or read status.
RES#	15	Reset signal input. When it's low, initialization of SSD1305 is executed.
CS#	16	Chip select input.
BS2	17	Interface select pin.
BS1	18	Interface select pin.
VDD	19	Power supply for logic circuit.
NC	20	No connection.
VSS	21	Ground.
VSS	22	Ground.

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7.4 GRAPHIC DISPLAY DATA RAM ADDRESS MAP

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is $132 \times 64 = 8448$ bits.

For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software.

				OUT	SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7	•••	SEG128	SEG129	SEG130	SEG131
				Column Address nap='0' Remap='1'	0x83h	0x82h	0x81h	0x80h	0x7Fh	0x7Eh	0x7Dh	0x7Ch		0x03h	0x02h	0x01h	0x00h
OUT	Row A Direction='1'	ddress Direction='0'		Column Remap='0'	400 x0	0x01h	0x 02h	0x 03h	0x 04h	0x 05h	0x 06h	0x 07h		0x 80h	0x81h	0x 82h	0x 83h
COM0	0x3Fh	0x00h		D0													
COM1	0x3Eh	0x01h		D1													
COM2	0x3Dh	0x02h		D2													
COM3	0x3Ch	0x03h	PAGE 0	D3													
COM4	0x3Bh	0x04h		D4													_
COM5	0x3Ah	0x05h		<u>D5</u>													
COM6 COM7	0x39h 0x38h	0x06h 0x07h		<u>D6</u> D7													
COM8	0x37h	0x07H		D0													-
COM9	0x36h	0x09h		D1													
COM10	0x35h	0x0Ah		D2													
COM11	0x34h	0x0Bh	DA 0E 4	D3													
COM12	0x33h	0x0Ch	PAGE 1	D4													
COM13	0x32h	0x0Dh		D5													
COM14	0x31h	0x0Eh		D6													
COM15	0x30h	0x0Fh		D7													
COM16	0x2Fh	0x10h		D0													
COM17	0x2Eh	0x11h		D1													_
COM18	0x2Dh	0x12h		D2													_
COM19 COM20	0x2Ch 0x2Bh	0x13h 0x14h	PAGE 2	D3 D4													
COM21	0x2Ah	0x14n		D5													
COM22	0x29h	0x16h															
COM23	0x28h	0x17h		D6 D7													
• •	0.05	0.00		Inc									1				
COM48 COM49	0x0Fh 0x0Eh	0x30h 0x31h		D0 D1					\vdash			\vdash		\vdash			\dashv
COM50	0x0En 0x0Dh	0x31h		D2													-
COM51	0x0Ch	0x33h		D3													
COM52	0x0Bh	0x34h	PAGE 6	D3													-
COM53	0x0Ah	0x35h	İ	D5													
COM54	0x09h	0x36h		D6													
COM55	0x08h	0x37h		D7													
COM56	0x07h	0x38h		D0													
COM57	0x06h	0x39h		D1													
COM58	0x05h	0x3Ah		D2													
COM59	0x04h	0x3Bh	PAGE 7	D3													
COM60	0x03h	0x3Ch	- "-	D4													_
COM61	0x02h	0x3Dh		<u>D5</u>													—
COM62	0x01h	0x3Eh		<u>D6</u> D7			\vdash					\vdash		\vdash			-
COM63	0x00h	0x3Fh		IJſ													

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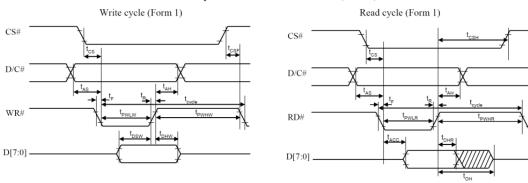
7.5 INTERFACE TIMING CHART

8080-Series MCU Parallel Interface Timing Characteristics

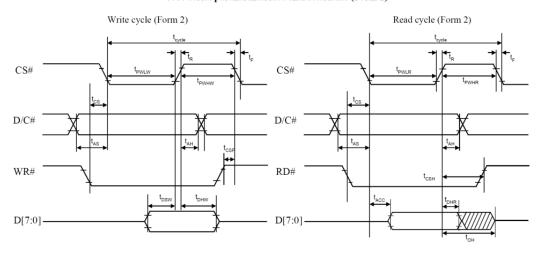
 $(V_{DD} - V_{SS} = 2.4 \text{V to } 3.5 \text{V}, V_{DDIO} = V_{DD}, T_A = 25 ^{\circ}\text{C})$

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	300	-	-	ns
t _{AS}	Address Setup Time	10	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
$t_{\rm DHW}$	Write Data Hold Time	7	-	-	ns
$t_{\rm DHR}$	Read Data Hold Time	20	-	-	ns
t _{OH}	Output Disable Time	-	-	70	ns
t _{ACC}	Access Time	-	-	140	ns
t _{PWLR}	Read Low Time	120	-	-	ns
t_{PWLW}	Write Low Time	60	-	-	ns
t_{PWHR}	Read High Time	60	-	-	ns
t_{PWHW}	Write High Time	60	-	-	ns
t_R	Rise Time	-	-	15	ns
$t_{\rm F}$	Fall Time	-	-	15	ns
t _{CS}	Chip select setup time	0	-	-	ns
t_{CSH}	Chip select hold time to read signal	0	-	-	ns
t _{CSF}	Chip select hold time	20	-	-	ns

8080-series parallel interface characteristics (Form 1)



8080-series parallel interface characteristics (Form 2)



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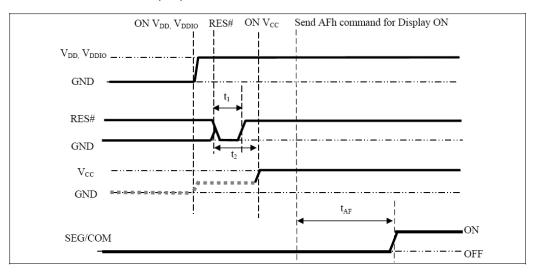


8. POWER ON / OFF SEQUENCE & APPLICATION CIRCUIT

8.1 POWER ON / OFF SEQUENCE

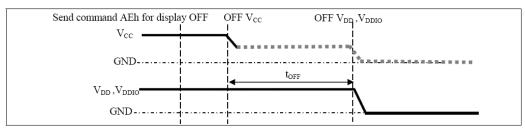
Power ON sequence:

- 1. Power ON VDD, VDDIO.
- 2. After VDD, VDDIO become stable, set RES# pin LOW (logic low) for at least 3us(t1) and then HIGH (logic high).
- After set RES# pin LOW (logic low), wait for at least 3us(t2). Then Power ON Vcc.(1)
- 4. After Vcc become stable, send command AFh for display ON. SEG/COM will be ON after 100ms(taf).



Power OFF sequence:

- Send command AEh for display OFF.
- 2. Power OFF Vcc. (1), (2)
- 3. Wait for toff. Power OFF VDD, VDDIO. (where Minimum toff=80ms, Typical toff=100ms)



Note:

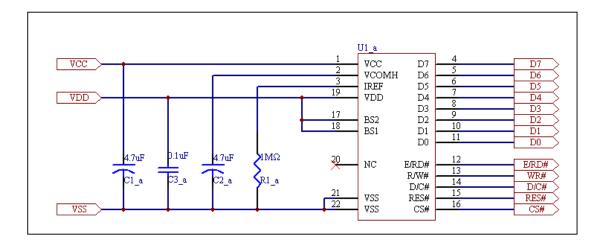
- (1) Since an ESD protection circuit is connected between VDD, VDDIO and VCC, VCC becomes lower than VDD whenever VDD, VDDIO is ON and VCC is OFF as shown in the dotted line of VCC in above figures.
- (2) Vcc should be disabled when it is OFF.

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8.2 APPLICATION CIRCUIT



8.3 COMMAND TABLE

Refer to SSD1305 IC Spec.

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9. RELIABILITY TEST CONDITIONS

No.	Items	Specification	Quantity
1	High temp. (Non-operation)	85°C, 240hrs	5
2	High temp. (Operation)	70°C, 120hrs	5
3	Low temp. (Operation)	-40°C, 120hrs	5
4	High temp. / High humidity (Operation)	65°C, 90%RH, 120hrs	5
5	Thermal shock (Non-operation)	-40°C ~85°C (-40°C /30min; transit /3min; 85°C /30min; transit /3min) 1cycle: 66min, 100 cycles	5
6	Vibration	Frequency: 5~50HZ, 0.5G Scan rate: 1 oct/min Time: 2 hrs/axis Test axis: X, Y, Z	1 Carton
7	Drop	Height: 120cm Sequence: 1 angle · 3 edges and 6 faces Cycles: 1	1 Carton
8	ESD (Non-operation)	Air discharge model, ±8kV, 10 times	5

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for item 1, 4 & 5.

Evaluation criteria

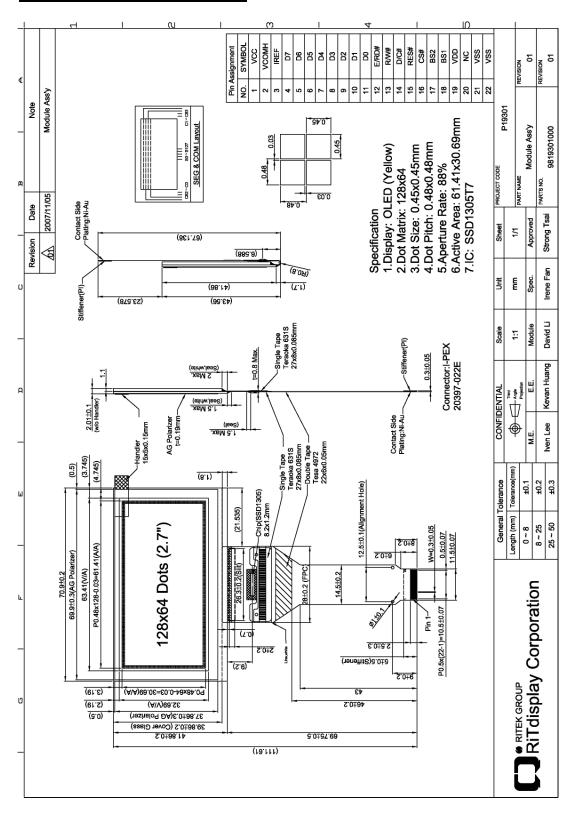
- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within \pm 50% of initial value.

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10. EXTERNAL DIMENSION



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11. PACKING SPECIFICATION

TBD

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12. APPENDIXES

APPENDIX 1: DEFINITIONS

A. DEFINITION OF CHROMATICITY COORDINATE

The chromaticity coordinate is defined as the coordinate value on the CIE 1931 color chart for R, G, B, W.

B. DEFINITION OF CONTRAST RATIO

The contrast ratio is defined as the following formula:

C. DEFINITION OF RESPONSE TIME

The definition of turn-on response time Tr is the time interval between a pixel reaching 10% of steady state luminance and 90% of steady state luminance. The definition of turn-off response time Tf is the time interval between a pixel reaching 90% of steady state luminance and 10% of steady state luminance. It is shown in Figure 2.

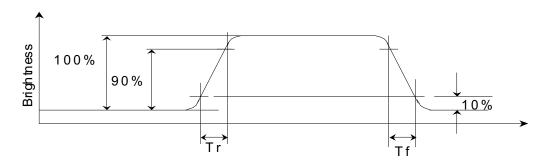


Figure 2 Response time

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D. DEFINITION OF VIEWING ANGLE

The viewing angle is defined as Figure 3. Horizontal and vertical (H & V) angles are determined for viewing directions where luminance varies by 50% of the perpendicular value.

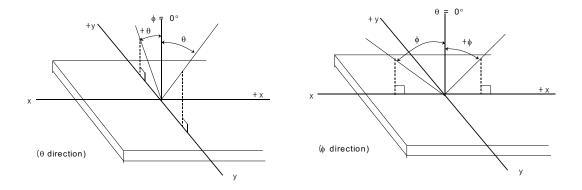


Figure 3 Viewing angle

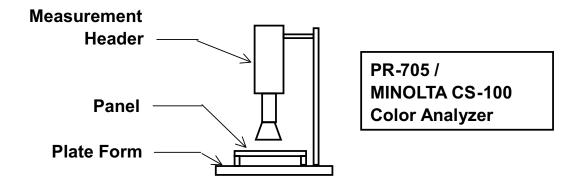




APPENDIX 2: MEASUREMENT APPARATUS

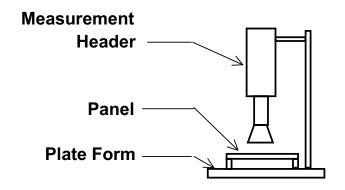
A. LUMINANCE/COLOR COORDINATE

PHOTO RESEARCH PR-705, MINOLTA CS-100



B. CONTRAST / RESPONSE TIME / VIEW ANGLE

WESTAR CORPORATION FPM-510



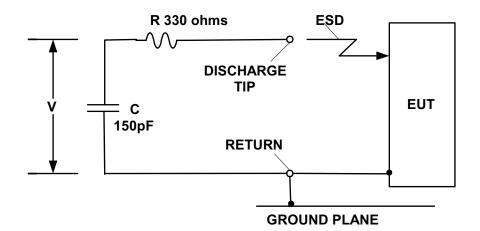
Westar FPM-510
Display Contrast /
Response time /
View angle Analyzer

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C. ESD ON AIR DISCHARGE MODE







APPENDIX 3: PRECAUTIONS

A. RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

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